

# THS1401-EP THS1403-EP THS1408-EP 14-BIT, 1/3/8 MSPS DSP COMPATIBLE ANALOG-TO-DIGITAL CONVERTERS WITH INTERNAL REFERENCE AND PGA

SGLS129A – JULY 2002 – REVISED NOVEMBER 2002

## features

- **Controlled Baseline**
  - One Assembly/Test Site, One Fabrication Site
- **Extended Temperature Performance up to –55°C to 125°C**
- **Enhanced Diminishing Manufacturing Sources (DMS) Support**
- **Enhanced Product Change Notification**
- **Qualification Pedigree†**
- **14-Bit Resolution**
- **1, 3, and 8 MSPS Speed Grades**
- **Differential Nonlinearity (DNL)  $\pm 0.6$  LSB Typ**

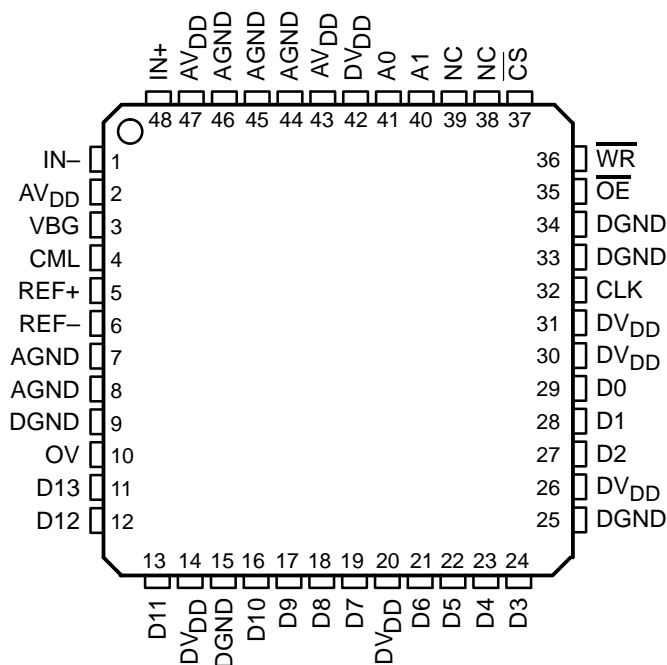
† Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

- **Integral Nonlinearity (INL)  $\pm 1.5$  LSB Typ**
- **Internal Reference**
- **Differential Inputs**
- **Programmable Gain Amplifier**
- **$\mu$ P Compatible Parallel Interface**
- **Timing Compatible With TMS320C6000 DSP**
- **3.3-V Single Supply**
- **Power-Down Mode**
- **Monolithic CMOS Design**

## applications

- **xDSL Front Ends**
- **Communication**
- **Industrial Control**
- **Instrumentation**
- **Automotive and Selected Military**

PHP PACKAGE  
(TOP VIEW)



NC – No internal connection



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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## description

The THS1401, THS1403, and THS1408 are 14-bit, 1/3/8 MSPS, single supply analog-to-digital converters with an internal reference, differential inputs, programmable input gain, and an on-chip sample and hold amplifier.

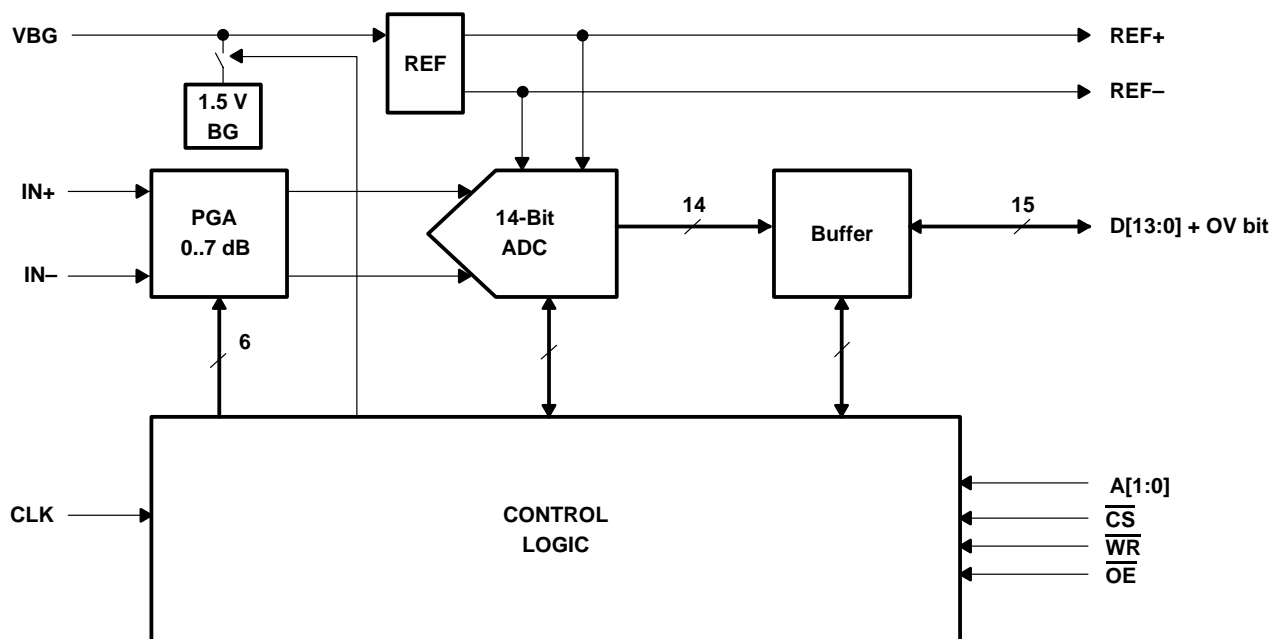
Implemented with a CMOS process, the device has outstanding price/performance and power/speed ratios. The THS1401, THS1403, and THS1408 are designed for use with 3.3-V systems, and with a high-speed  $\mu$ P compatible parallel interface, making them the first choice for solutions based on high-performance DSPs like the TI TMS320C6000 series.

## ORDERING INFORMATION

T <sub>A</sub>	PACKAGE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 125°C	PQFP – PHP	THS1401QPHPEP	THS1401QE
–40°C to 125°C	PQFP – PHP	THS1403QPHPEP	THS1403QE
–55°C to 125°C	PQFP – PHP	THS1408MPHPEP	THS1408ME

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

## functional block diagram



**THS1401-EP THS1403-EP THS1408-EP**  
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**Terminal Functions**

TERMINAL NAME NO.		I/O	DESCRIPTION
A[1:0]	40, 41	I	Address input
AGND	7, 8, 44, 45, 46		Analog ground
AV <sub>DD</sub>	2, 43, 47		Analog power supply
CLK	32	I	Clock input
CML	4		Reference midpoint. This pin requires a 0.1-μF capacitor to AGND.
$\overline{\text{CS}}$	37	I	Chip select input. Active low
DGND	9, 15, 25, 33, 34		Digital ground
DV <sub>DD</sub>	14, 20, 26, 30, 31, 42		Digital power supply
D[13:0]	11, 12, 13, 16, 17, 18, 19, 21, 22, 23, 24, 27, 28, 29	I/O	Data inputs/outputs
NC	38, 39		No connection, do not use. Reserved
IN+	48	I	Positive differential analog input
IN–	1	I	Negative differential analog input
$\overline{\text{OE}}$	35	I	Output enable. Active low
OV	10	O	Out of range output
REF+	5	O	Positive reference output. This pin requires a 0.1-μF capacitor to AGND.
REF–	6	O	Negative reference output. This pin requires a 0.1-μF capacitor to AGND.
VBG	3	I	Reference input. This pin requires a 1-μF capacitor to AGND.
$\overline{\text{WR}}$	36	I	Write signal. Active low



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## absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage, (AV <sub>DD</sub> to AGND)	4V
Supply voltage, (DV <sub>DD</sub> to DGND)	4V
Reference input voltage range, VBG	– 0.3 V to AV <sub>DD</sub> + 0.3 V
Analog input voltage range	– 0.3 V to AV <sub>DD</sub> + 0.3 V
Digital input voltage range	– 0.3 V to DV <sub>DD</sub> + 0.3 V
Operating free-air temperature range, T <sub>A</sub> : Q suffix	–40°C to 125°C
M suffix	–55°C to 125°C
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## THERMAL CHARACTERISTICS

	TYP	UNIT
Thermal resistance, junction-to-ambient, $\theta_{JA}$	28.8	°C/W
Thermal resistance, junction-to-case, $\theta_{JC}$	0.79	°C/W

† Thermal resistance is modeled data, is not production tested, and is given for informational purposes only.

## recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, AV <sub>DD</sub> , DV <sub>DD</sub>		3	3.3	3.6	V
High level digital input, V <sub>IH</sub>		2	3.3		V
Low level digital input, V <sub>IL</sub>			0	0.8	V
Load capacitance, C <sub>L</sub>			5	15	pF
Clock frequency, f <sub>CLK</sub>	THS1401	0.1	1	1	MHz
	THS1403	0.1	3	3	MHz
	THS1408	0.1	8	8	MHz
Clock duty cycle		45%	50%	55%	
Operating free-air temperature	Q suffix	–40	25	125	°C
	M suffix	–55	25	125	



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**electrical characteristics over recommended operating free-air temperature range,**  
 **$AV_{DD} = DV_{DD} = 3.3\text{ V}$  (unless otherwise noted)**

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>Power Supply</b>							
$I_{DDA}$	Analog supply current		$AV_{DD} = 3.6\text{ V}$		81	90	mA
$I_{DDD}$	Digital supply current		$DV_{DD} = 3.6\text{ V}$		5	10	mA
	Power		$AV_{DD} = DV_{DD} = 3.6\text{ V}$		270	360	mW
	Power down current				20		$\mu\text{A}$
<b>DC Characteristics</b>							
	Resolution				14		Bits
DNL	Differential nonlinearity				$\pm 0.6$	$\pm 1$	LSB
INL	Integral nonlinearity	THS1401	Best fit		$\pm 1.5$	$\pm 2.5$	LSB
		THS1403			$\pm 2$	$\pm 3$	
		THS1408			$\pm 3.5$	$\pm 7.5$	
	Offset error		$IN+ = IN-, PGA = 0\text{ dB}$			0.3	%FSR
	Gain error		$PGA = 0\text{ dB}$			1.75	%FSR
<b>AC Characteristics</b>							
ENOB	Effective number of bits			11.2	11.5		Bits
THD	Total harmonic distortion	THS1401/3/8	$f_i = 100\text{ kHz}$		-81		dB
		THS1403/8	$f_i = 1\text{ MHz}$		-78		
		THS1408	$f_i = 4\text{ MHz}$		-77		
SNR	Signal-to-noise ratio	THS1401/3/8	$f_i = 100\text{ kHz}$		72		dB
		THS1403/8	$f_i = 1\text{ MHz}$	70	72		
		THS1408	$f_i = 4\text{ MHz}$		71		
SINAD	Signal-to-noise ratio + distortion	THS1401/3/8	$f_i = 100\text{ kHz}$		70		dB
		THS1403/8	$f_i = 1\text{ MHz}$	69	70		
		THS1408	$f_i = 4\text{ MHz}$		70		
SFDR	Spurious free dynamic range	THS1401/3/8	$f_i = 100\text{ kHz}$		80		dB
		THS1403, THS1408	$f_i = 1\text{ MHz}$	71	80		
		THS1408	$f_i = 4\text{ MHz}$		80		
	Analog input bandwidth				140		MHz

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**electrical characteristics over recommended operating free-air temperature range,**  
 **$AV_{DD} = DV_{DD} = 3.3$  V (unless otherwise noted) (continued)**

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>Reference Voltage</b>						
V <sub>BG</sub>	Bandgap voltage, internal mode		1.425	1.5	1.575	V
	Input impedance			40		k $\Omega$
	Positive reference voltage, REF+			2.5		V
	Negative reference voltage, REF–			0.5		V
	Reference difference, $\Delta$ REF, REF+ – REF–			2		V
	Accuracy, internal reference			5%		
	Temperature coefficient			40		ppm/°C
	Voltage coefficient			200		ppm/V
<b>Analog Inputs</b>						
	Positive analog input, IN+		0	$AV_{DD}$		V
	Negative analog input, IN–		0	$AV_{DD}$		V
	Analog input voltage difference	$\Delta A_{in} = IN+ - IN-, V_{ref} = REF+ - REF-$	$-V_{ref}$		$V_{ref}$	V
	Input impedance			25		k $\Omega$
	PGA range		0		7	dB
	PGA step size			1		dB
	PGA gain error				$\pm 0.25$	dB
<b>Digital Inputs</b>						
V <sub>IH</sub>	High-level digital input		2			V
V <sub>IL</sub>	Low-level digital input				0.8	V
	Input capacitance			5		pF
	Input current				$\pm 1$	$\mu$ A
<b>Digital Outputs</b>						
V <sub>OH</sub>	High-level digital output	$I_{OH} = 50 \mu$ A	2.6			V
V <sub>OL</sub>	Low-level digital output	$I_{OL} = 50 \mu$ A			0.4	V
I <sub>OZ</sub>	Output current, high impedance				$\pm 10$	$\mu$ A
<b>Clock Timing (CS low)</b>						
f <sub>CLK</sub>	Clock frequency	THS1401	0.1 <sup>†</sup>	1	1	MHz
		THS1403	0.1 <sup>†</sup>	3	3	MHz
		THS1408	0.1 <sup>†</sup>	8	8	MHz
t <sub>d</sub>	Output delay time				25	ns
	Latency			9.5		Cycles

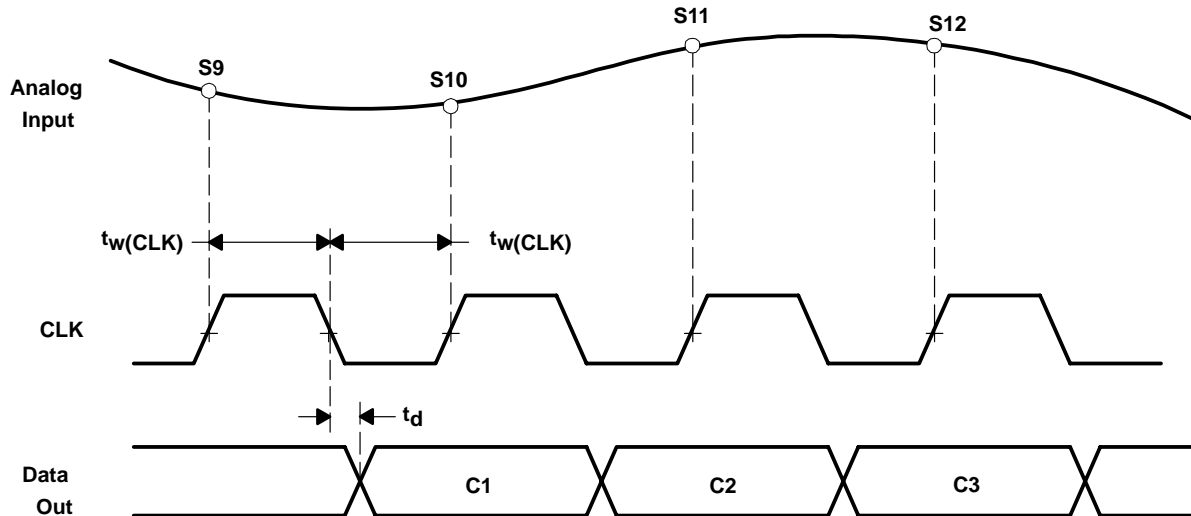
<sup>†</sup> This parameter is not production tested.



## PARAMETER MEASUREMENT INFORMATION

### sample timing

The THS1401/3/8 core is based on a pipeline architecture with a latency of 9.5 samples. The conversion results appear on the digital output 9.5 clock cycles after the input signal was sampled.



**Figure 1. Sample Timing**

The parallel interface of the THS1401/3/8 ADC features 3-state buffers, making it possible to directly connect it to a data bus. The output buffers are enabled by driving the OE input low.

Besides the sample results, it is also possible to read back the values of the control register, the PGA register, and the offset register. Which register is read is determined by the address inputs A[1,0]. The ADC results are available at address 0.

The timing of the control signals is described in the following sections.

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## PARAMETER MEASUREMENT INFORMATION

### read timing (15-pF load)

PARAMETER	MIN	TYP	MAX	UNIT
$t_{su}(OE-ACS)$ Address and chip select setup time	4			ns
$t_{en}$ Output enable			15	ns
$t_{dis}$ Output disable		10		ns
$t_h(A)$ Address hold time	1			ns
$t_h(CS)$ Chip select hold time	0			ns

NOTE: All timing parameters refer to a 50% level.

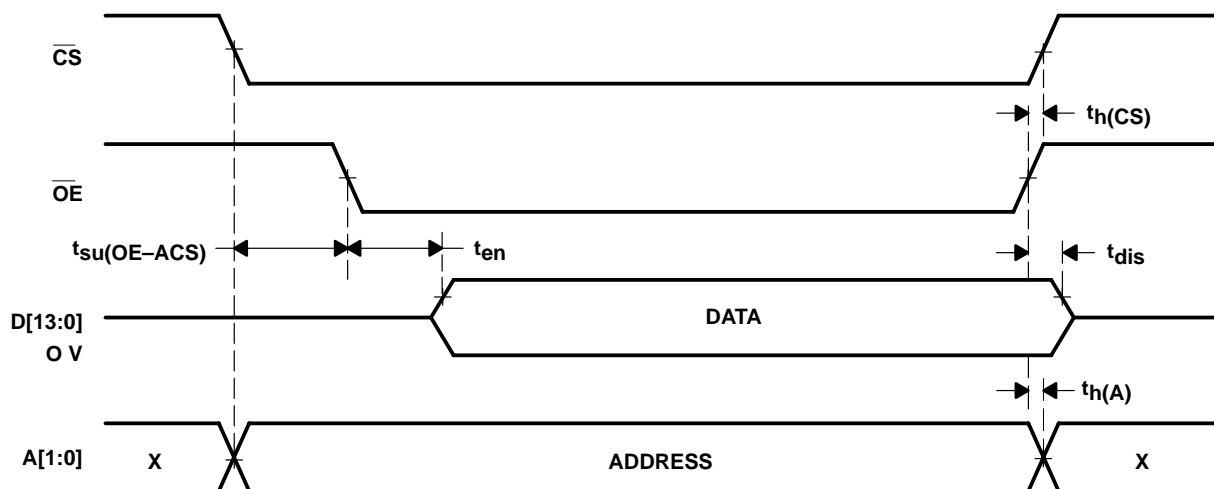


Figure 2. Read Timing



## PARAMETER MEASUREMENT INFORMATION

### write timing (15-pF load)

PARAMETER	MIN	TYP	MAX	UNIT
$t_{su}(WE-CS)$ Chip select setup time	4			ns
$t_{su}(DA)$ Data and address setup time	29			ns
$t_h(DA)$ Data and address hold time	0			ns
$t_h(CS)$ Chip select hold time	0			ns
$t_{wH}(WE)$ Write pulse duration high	15			ns

NOTE: All timing parameters refer to a 50% level.

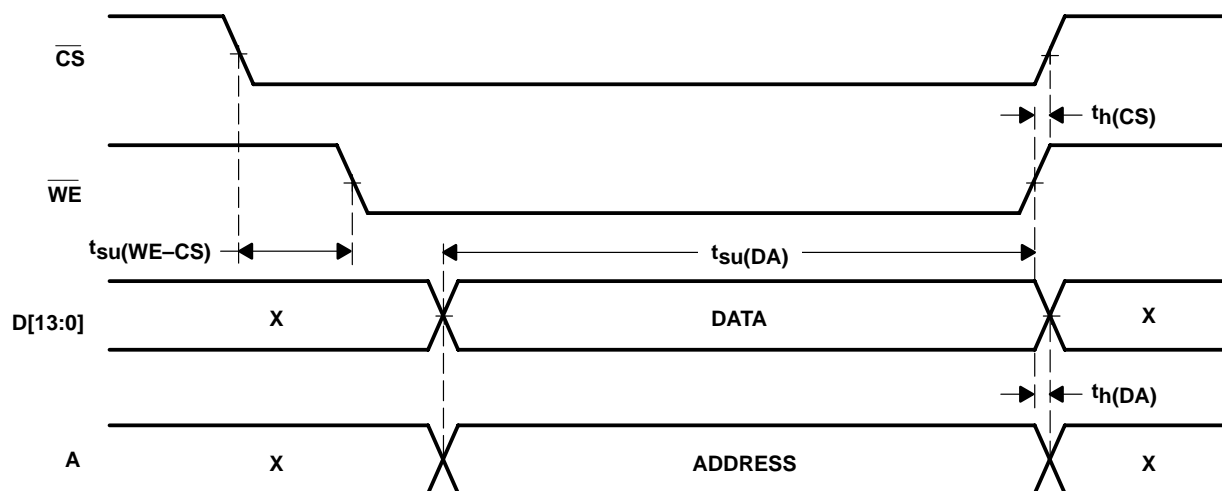


Figure 3. Write Timing

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## TYPICAL CHARACTERISTICS

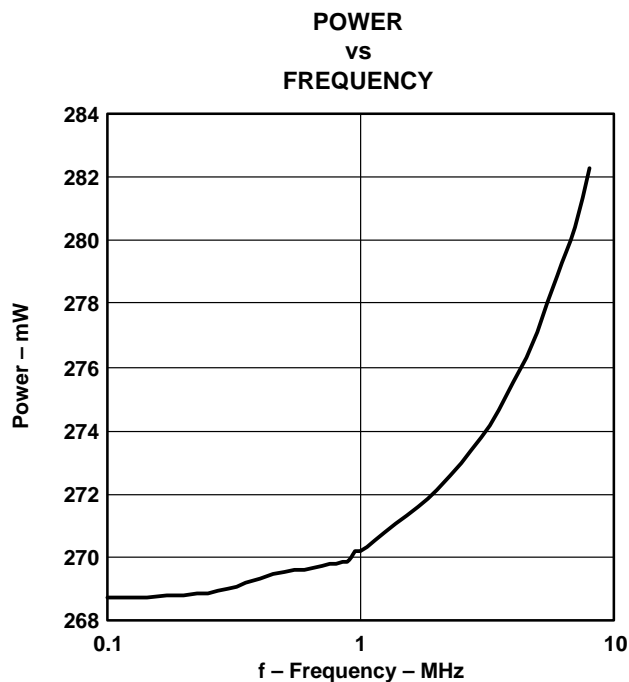


Figure 4

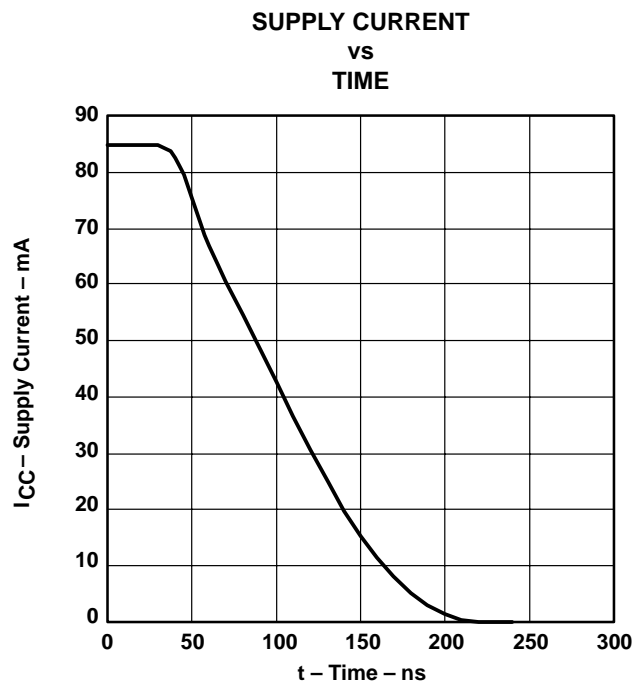


Figure 5

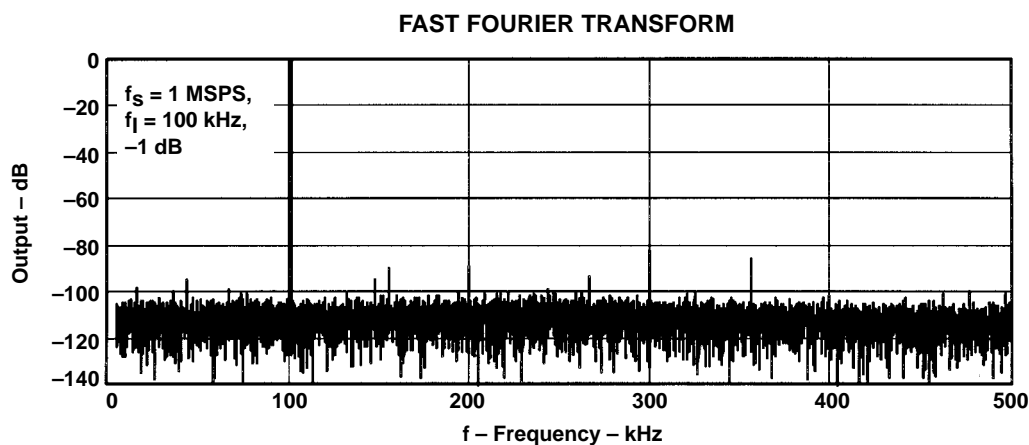


Figure 6

## TYPICAL CHARACTERISTICS

### FAST FOURIER TRANSFORM

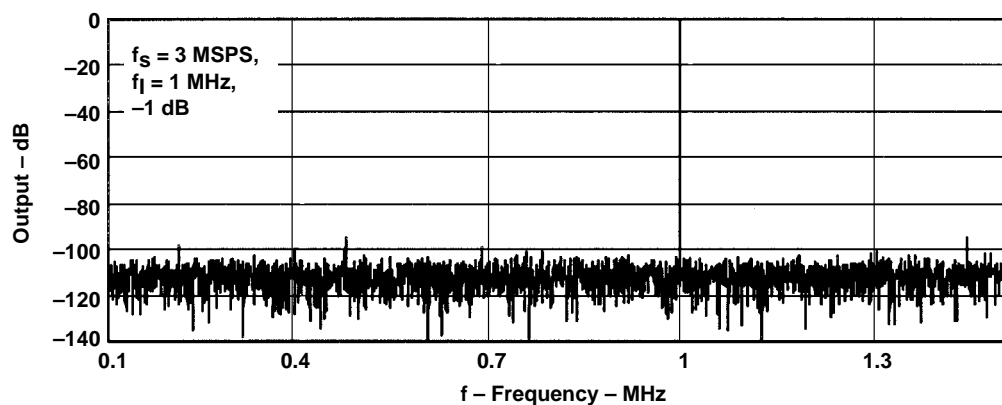


Figure 7

### FAST FOURIER TRANSFORM

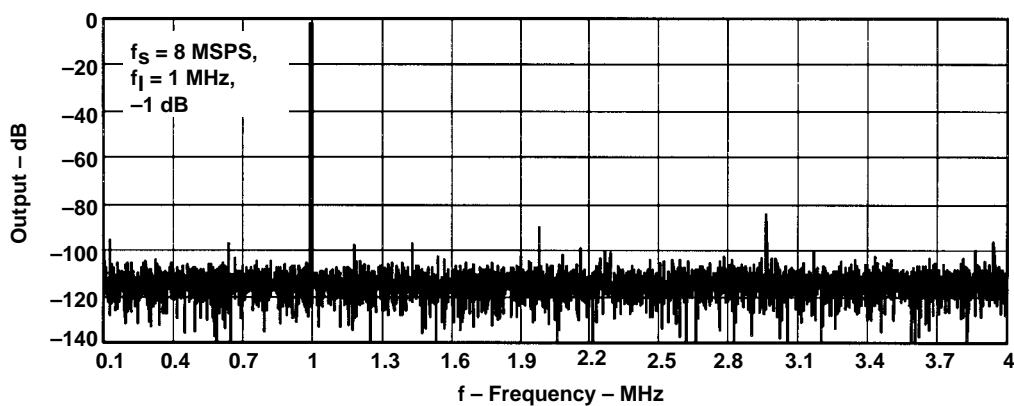


Figure 8

### INTEGRAL NONLINEARITY

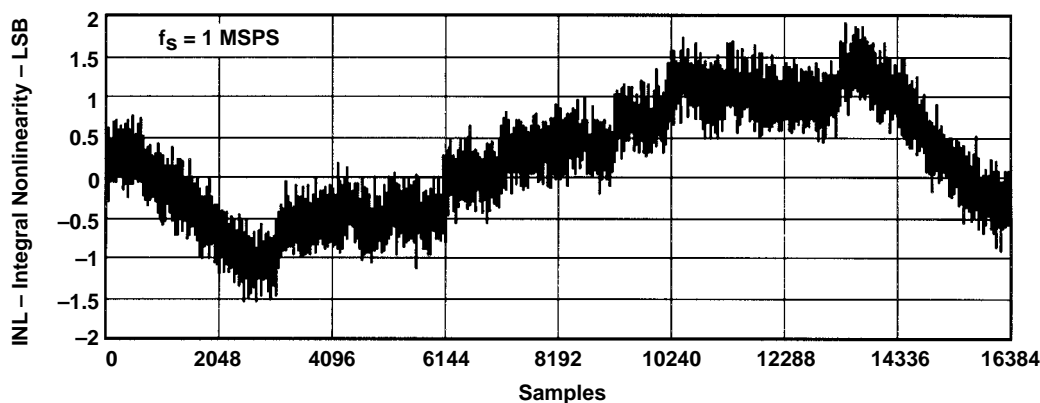


Figure 9

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TYPICAL CHARACTERISTICS

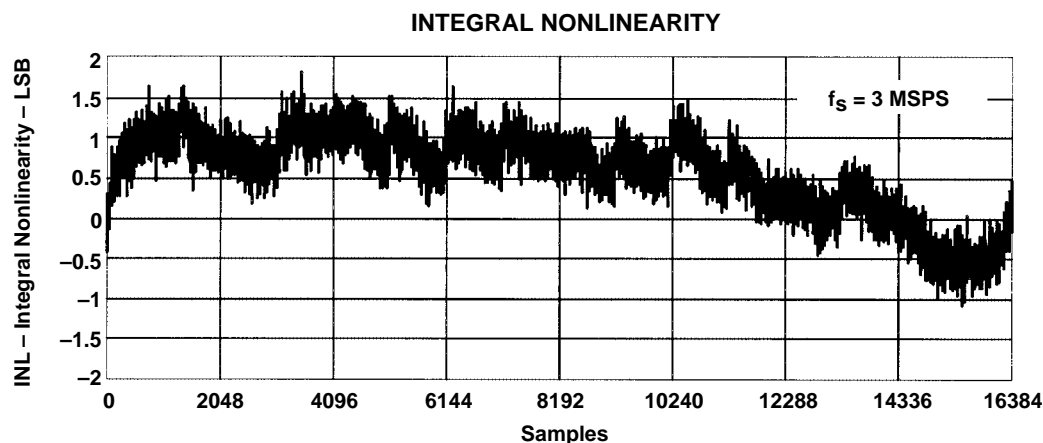


Figure 10

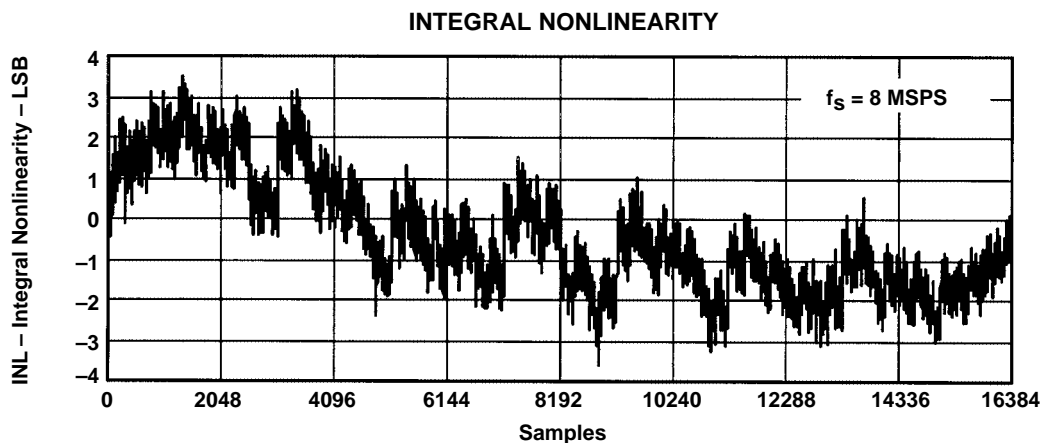


Figure 11

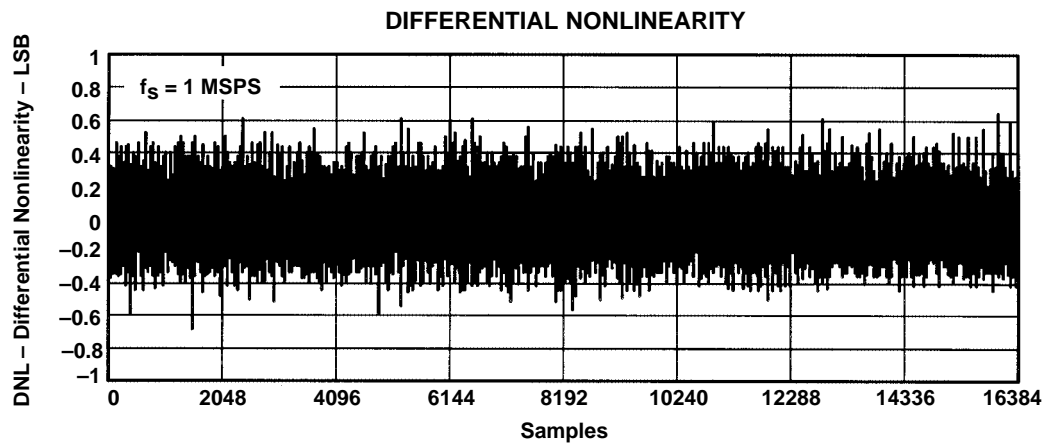


Figure 12

## TYPICAL CHARACTERISTICS

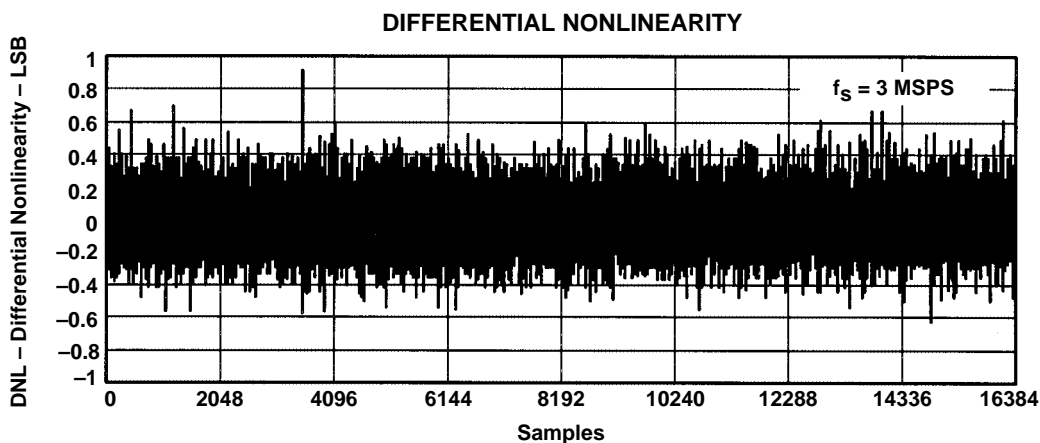


Figure 13

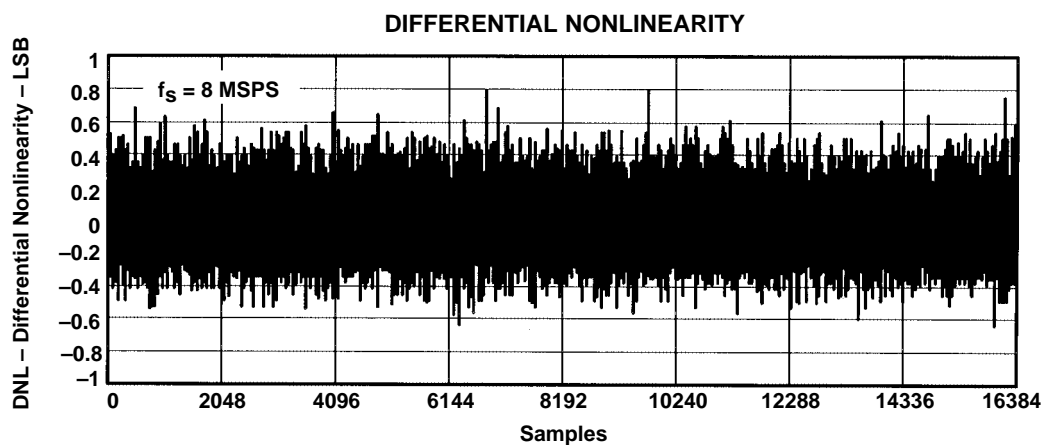
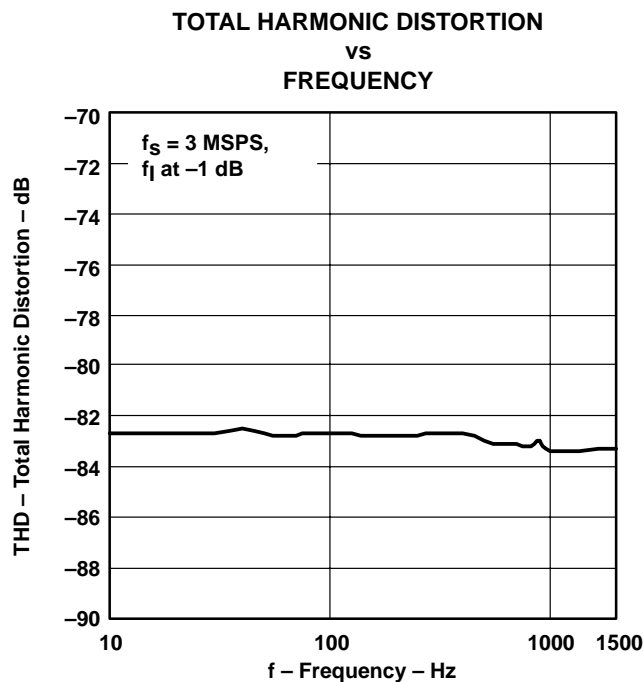


Figure 14

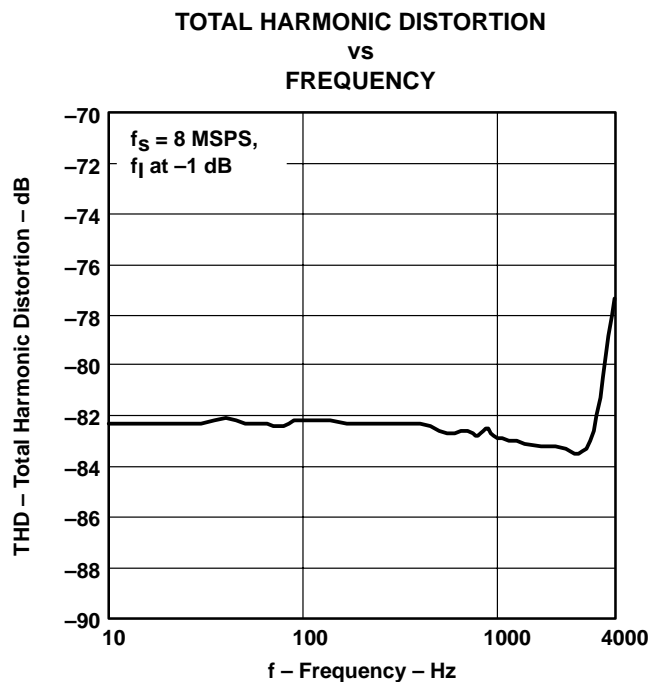
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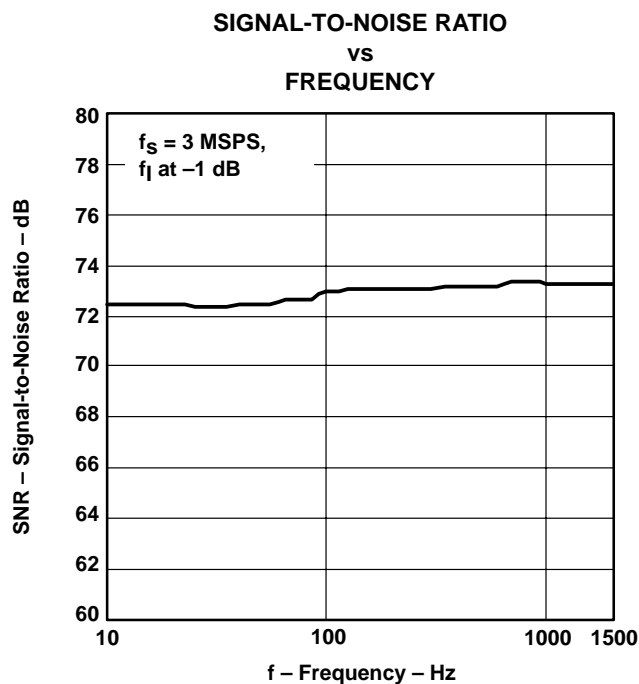
**TYPICAL CHARACTERISTICS**



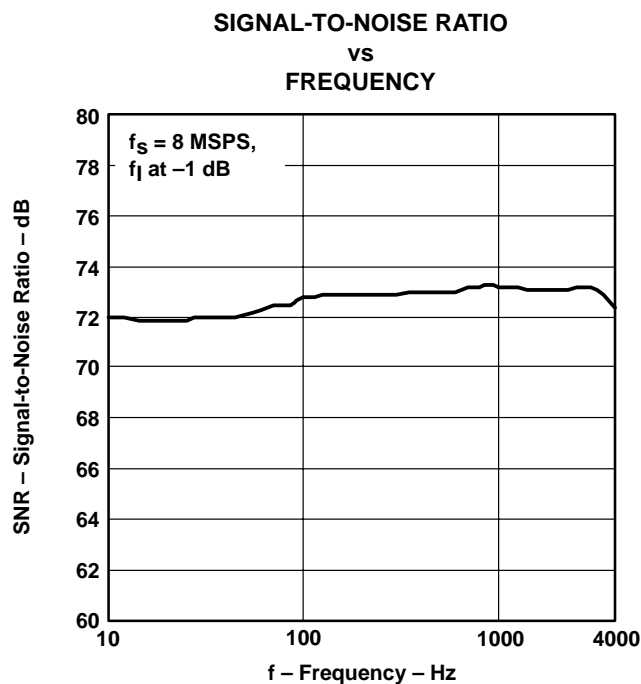
**Figure 15**



**Figure 16**



**Figure 17**



**Figure 18**

## PRINCIPLES OF OPERATION

### registers

The device contains several registers. The A register is selected by the values of bits A1 and A0:

A1	A0	Register
0	0	Conversion result
0	1	PGA
1	0	Offset
1	1	Control

Tables 1 and 2 describe how to read the conversion results and how to configure the data converter. The default values (were applicable) show the state after a power-on reset.

**Table 1. Conversion Result Register, Address 0, Read**

BIT	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Function	MSB	...	...	...	...	...	...	...	...	...	...	...	...	LSB

The output can be configured for two's complement or straight binary format (see D11/control register).

The output code is given by:

2s complement:

–8192 at  $\Delta IN = -\Delta REF$

0 at  $\Delta IN = 0$

8191  $\Delta IN = -\Delta REF - 1 \text{ LSB}$

Straight binary:

0 at  $\Delta IN = -\Delta REF$

8192 at  $\Delta IN = 0$

16383 at  $\Delta IN = -\Delta REF - 1 \text{ LSB}$

$$1 \text{ LSB} = \frac{2\Delta REF}{16384}$$

**Table 2. PGA Gain Register, Address 1, Read/Write**

BIT	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Function	X	X	X	X	X	X	X	X	X	X	X	G2	G1	G0
Default	0	0	0	0	0	0	0	0	0	0	0	0	0	0

The PGA gain is determined by writing to G2–0.

Gain (dB) = 1dB × G2–0. max = 7dB. The range of G2–0 is 0 to 7.

**Table 3. Offset Register, Address 2, Read/Write**

BIT	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Function	X	X	X	X	X	X	MSB	...	...	...	...	...	...	LSB
Default	0	0	0	0	0	0	0	0	0	0	0	0	0	0

The offset correction range is from –128 to 127 LSB. This value is added to the conversion results from the ADC.

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**PRINCIPLES OF OPERATION**

**Table 4. Control Register, Address 3, Read**

BIT	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Function	PWD	REF	FOR	TM2	TM1	TM0	OFF	RES	RES	RES	RES	RES	RES	RES

**Table 5. Control Register, Address 3, Write**

BIT	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Function	PWD	REF	FOR	TM2	TM1	TM0	OFF	RES	RES	RES	RES	RES	RES	RES
Default	0	0	0	0	0	0	0	0	0	0	0	0	0	0

PWD:	Power down	0 = normal operation	1 = power down
REF:	Reference select	0 = internal reference	1 = external reference
FOR:	Output format	0 = straight binary	1 = 2s complement
TM2–0:	Test mode	000 = normal operation 001 = both inputs = REF– 010 = IN+ at $V_{ref}/2$ , IN– at REF– 011 = IN+ at REF+, IN– at REF– 100 = normal operation 101 = both inputs = REF+ 110 = IN+ at REF–, IN– at $V_{ref}/2$ 111 = IN+ at REF–, IN– at REF+	
OF:	Offset correction	0 = enable	1 = disable
RES	Reserved	Must be set to 0.	





## APPLICATION INFORMATION

### driving the analog input

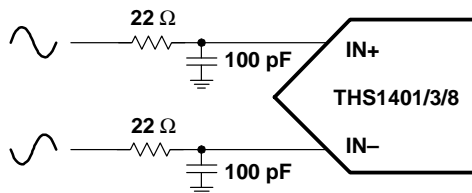
The THS1401/3/8 ADCs have a fully differential input. A differential input is advantageous with respect to SNR, SFDR, and THD performance because the signal peak-to-peak level is 50% of a comparable single-ended input.

There are three basic input configurations:

- Fully differential
- Transformer coupled single-ended to differential
- Single-ended

### fully differential configuration

In this configuration, the ADC converts the difference ( $\Delta IN$ ) of the two input signals on IN+ and IN–.



**Figure 19. Differential Input**

The resistors and capacitors on the inputs decouple the driving source output from the ADC input and also serve as first order low pass filters to attenuate out of band noise.

The input range on both inputs is 0 V to  $AV_{DD}$ . The full-scale value is determined by the voltage reference. The positive full-scale output is reached, if  $\Delta IN$  equals  $\Delta REF$ , the negative full-scale output is reached, if  $\Delta IN$  equals  $-\Delta REF$ .

$\Delta IN$ [V]	OUTPUT
$-\Delta REF$	– full scale
0	0
$\Delta REF$	+ full scale

## APPLICATION INFORMATION

### transformer coupled single-ended to differential configuration

If the application requires the best SNR, SFDR, and THD performance, the input should be transformer coupled.

The signal amplitude on both inputs of the ADC is one half as high as in a single-ended configuration thus increasing the ADC ac performance.

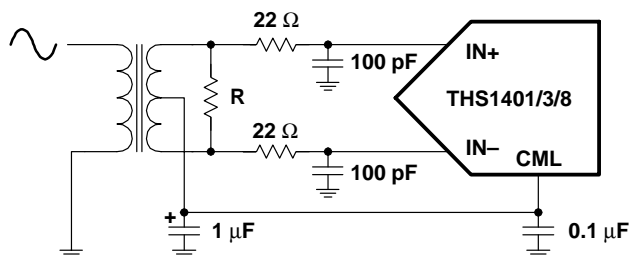


Figure 20. Transformer Coupled

The following table shows the input voltages for negative full-scale output, zero output, and positive full-scale output:

IN [V <sub>PEAK</sub> ]	OUTPUT [PEAK]
$-\Delta\text{REF}$	– full scale <sup>†</sup>
0	0
$\Delta\text{REF}$	+ full scale <sup>†</sup>

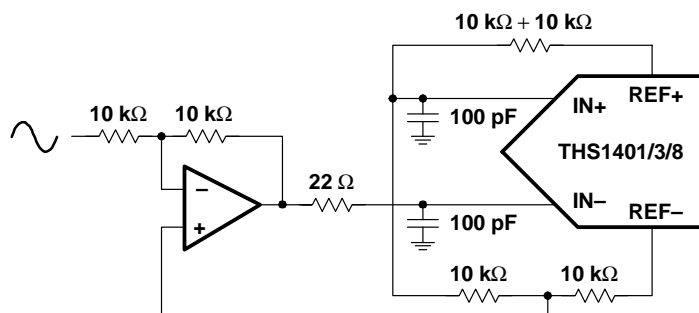
<sup>†</sup>  $n = 1$  (winding ratio)

The resistor R of the transformer coupled input configuration must be set to match the signal source impedance  $R = n^2 R_s$ , where  $R_s$  is the source impedance and  $n$  is the transformer winding ratio.

## APPLICATION INFORMATION

### single-ended configuration

In this configuration, the input signal is level shifted by  $\Delta\text{REF}/2$ .



**Figure 21. Single-Ended With Level Shift**

The following table shows the input voltages for negative full-scale output, zero output, and positive full-scale output:

$\Delta\text{IN+ [V]}$	OUTPUT
$-\Delta\text{REF}$	– full scale
0	0
$\Delta\text{REF}$	+ full scale

Note that the resistors of the op-amp and the op-amp all introduce gain and offset errors. Those errors can be trimmed by varying the values of the resistors.

Because of the added offset, the op-amp does not necessarily operate in the best region of its transfer curve (best linearity around zero) and therefore may introduce unacceptable distortion. For ac signals, an alternative is described in the following section.

## APPLICATION INFORMATION

### AC-coupled single-ended configuration

If the application does not require the signal bandwidth to include dc, the level shift shown in Figure 4 is not necessary.

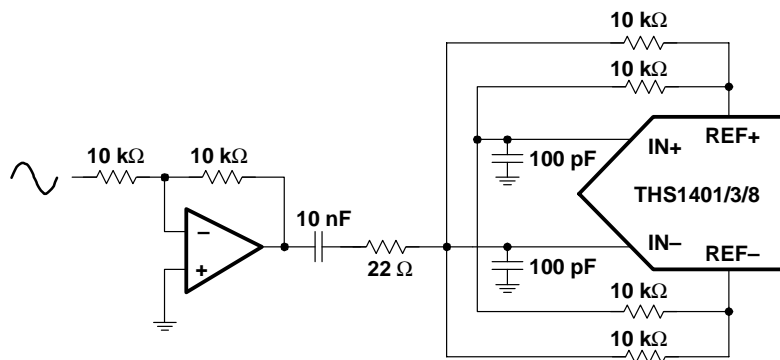


Figure 22. Single-Ended With Level Shift

Because the signal swing on the op-amp is centered around ground, it is more likely that the signal stays within the linear region of the op-amp transfer function, thus increasing the overall ac performance.

IN [V <sub>PEAK</sub> ]	OUTPUT [PEAK]
$-\Delta\text{REF}$	– full scale
0	0
$\Delta\text{REF}$	+ full scale

Compared to the transformer-coupled configuration, the swing on IN– is twice as big, which can decrease the ac performance (SNR, SFD, and THD).

## APPLICATION INFORMATION

### internal/external reference operation

The THS1401/3/8 ADC can either be operated using the built-in band gap reference or using an external precision reference in case very high dc accuracy is needed.

The REF+ and REF- outputs are given by:

$$\text{REF} + = \text{VBG} \left( 1 + \frac{2}{3} \right) \text{ and } \text{REF} - = \text{VBG} \left( 1 - \frac{2}{3} \right)$$

If the built-in reference is used, VBG equals 1.5 V which results in REF+ = 2.5 V, REF- = 0.5 V and  $\Delta\text{REF} = 2 \text{ V}$ .

The internal reference can be disabled by writing 1 to D12 (REF) in the control register (address 3). The band gap reference is then disconnected and can be substituted by a voltage on the VBG pin.

### programmable gain amplifier

The on-chip programmable gain amplifier (PGA) has eight gain settings. The gain can be changed by writing to the PGA gain register (address 1). The range is 0 to 7dB in steps of one dB.

### out of range indication

The OV output of the ADC indicates an out of range condition. Every time the difference on the analog inputs exceeds the differential reference, this signal is asserted. This signal is updated the same way as the digital data outputs and therefore subject to the same pipeline delay.

### offset compensation

With the offset register it is possible to automatically compensate system offset errors, including errors caused by additional signal conditioning circuitry. If the offset compensation is enabled (D7 (OFF) in the control register), the value in the offset register (address 2) is automatically subtracted from the output of the ADC.

In order to set the correct value of the offset compensation register, the ADC result when the input signal is 0 must be read by the host processor and written to the offset register (address 2).

### test modes

The ADC core operation can be tested by selecting one of the available test modes (see control register description). The test modes apply various voltages to the differential input depending on the setting in the control register.

### digital I/O

The digital inputs and outputs of the THS1401/3/8 ADC are 3-V CMOS compatible. In order to avoid current feed back errors, the capacitive load on the digital outputs should be as low as possible (50 pF max). Series resistors (100  $\Omega$ ) on the digital outputs can improve the performance by limiting the current during output transitions.

The parallel interface of the THS1401/3/8 ADC features 3-state buffers, making it possible to directly connect it to a data bus. The output buffers are enabled by driving the  $\overline{\text{OE}}$  input low.

Refer to the read and write timing diagrams in the parameter measurement information section for information on read and write access.

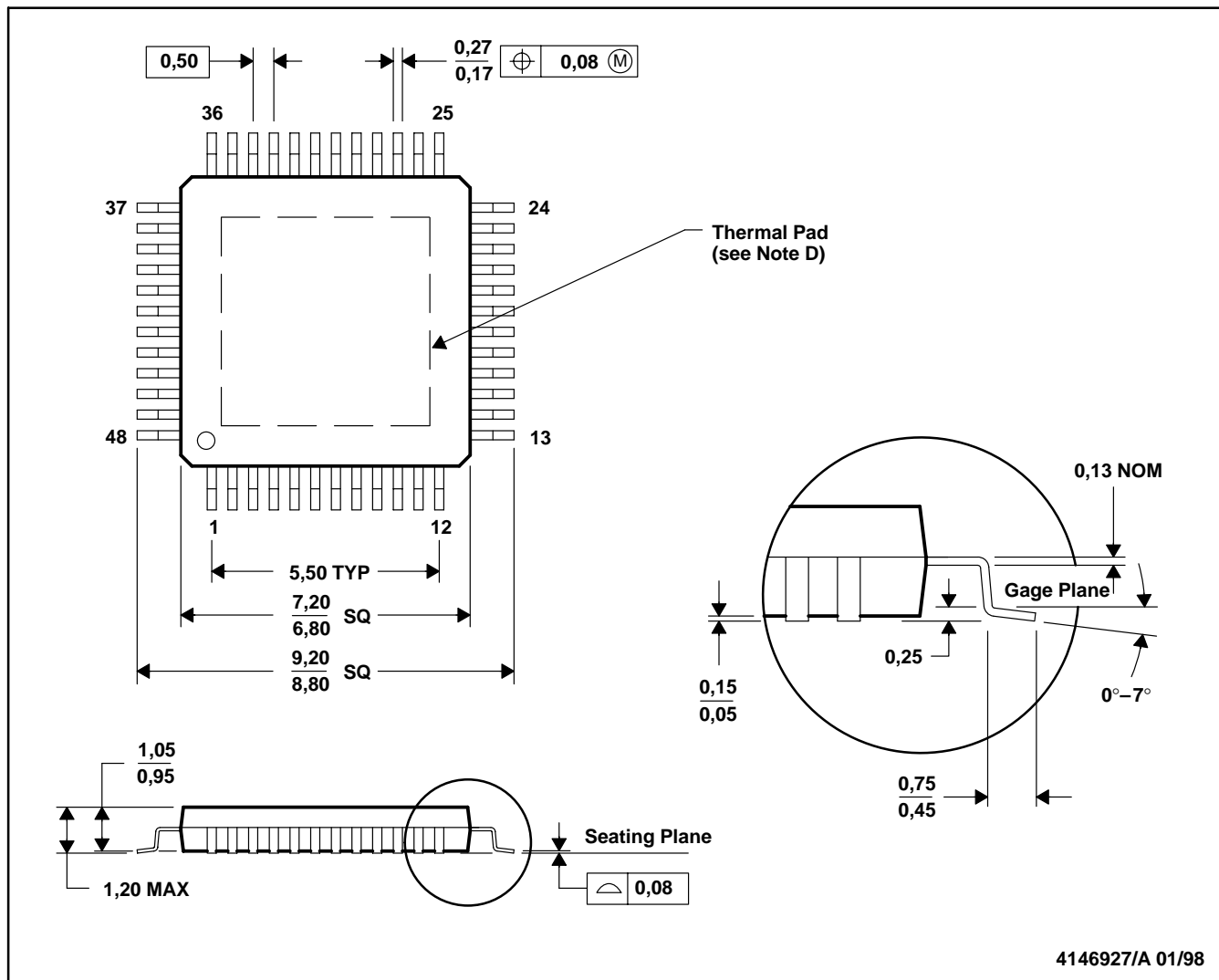
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**14-BIT, 1/3/8 MSPS DSP COMPATIBLE ANALOG-TO-DIGITAL CONVERTERS**  
**WITH INTERNAL REFERENCE AND PGA**

SGLS129A – JULY 2002 – REVISED NOVEMBER 2002

**MECHANICAL DATA**

**PHP (S-PQFP-G48)**

**PowerPAD™ PLASTIC QUAD FLATPACK**



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- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion.
  - D. The package thermal performance may be enhanced by bonding the thermal pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected leads.
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